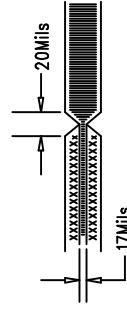
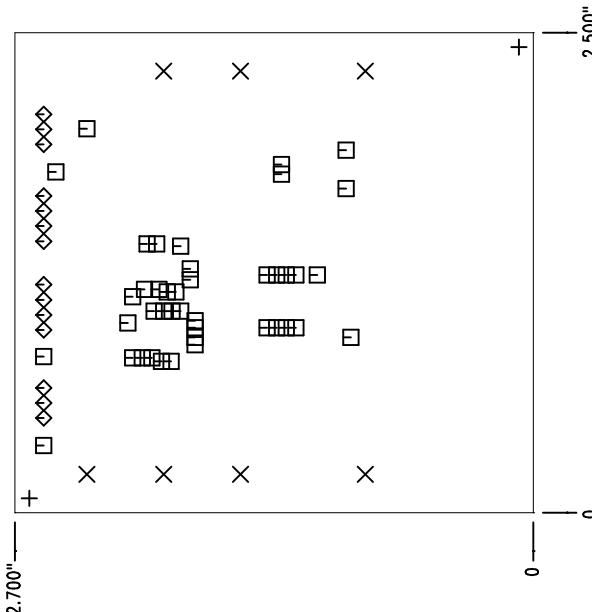


REV	REVISIONS	APPR	DATE
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NOTES: Unless Otherwise Specified:

1. PCBs Are To Be RoHS Compliant
2. Fab Per IPC-A-600
3. Material: Epoxy Fiberglass, NEMA Grade FR-4, 4 Layers .062 +/- .005 Inch Thickness With 2 OZ. Copper Finished On All Outer Layers, 1 OZ. Copper On All Internal Layers.
4. Size: Cut To Dimensions And Tolerances Shown.
5. Finish: SMOBC Using Wet Mask, Or LPI Both Sides, Color Green. Silkscreen Component Side With White Non-Conductive Ink, Gold Immersion Both Sides (Not Required For Prototype Boards)
6. Drilling: Drill Holes Per Schedule. Plate Through Holes With Copper, .001 Inch Thick Min. All Hold Sizes Are Specified After Plating. Holes Location Tolerances Are +/- .005" In Relation To Center.
7. Do Not Alter Artwork To Add Logo Or Date Code, But You May Modify Pad Size To Meet End Finish.
8. Scoring: (Not Required For Prototype Boards)



Fabrication Drawing

APPROVALS		DRAWN		INIT		DATE	
				KL			
DRAWN							
CHECK							
DESIGN							
ENGR							

TITLE: LTC3834FGN-1  
1630 McCarthy Blvd.  
Milpitas, CA 95035  
PH: (408)432-1900

SIZE	QTY	SYM	PLATED	TOL			
70	2	+	NO	+/-0.0			
94	7	X	YES	+/-0.0			
15	42	◻	YES	+/-0.0			
40	14	◇	YES	+/-0.0			

ART01 = LAYER 1 (COMPONENT SIDE)  
ART02 = LAYER 2 (GND)  
ART03 = LAYER 3 (GND)  
ART04 = LAYER 4 (SOLDER SIDE)

SCALE = NONE DESIGN #

SIZE      NONE      DESIGN #

REV. A

SHT 1 of 1